

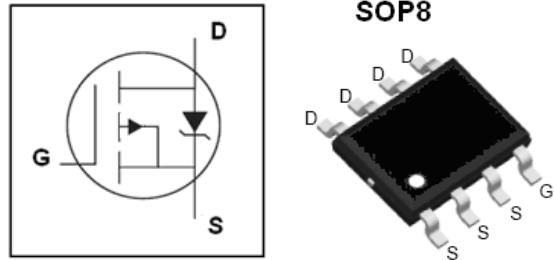
## Features

- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ Repetitive Avalanche Allowed up to Tjmax
- ◆ Lead-Free, RoHS Compliant

$V_{DS}$	-30	V
$R_{DS(on),typ} @ V_{GS} = -10V$	11	mΩ
$R_{DS(on),typ} @ V_{GS} = -4.5V$	15	mΩ
$I_D$	-13	A

## Description

**VS4407AS** designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 150°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Power applications and a wide variety of other supply applications.



## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (TA=25°C Unless Otherwise Noted)</b>				
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	-30	V	
$T_J$	Maximum Junction Temperature	150	°C	
$T_{STG}$	Storage Temperature Range	-55 to 150	°C	
$I_S$	Diode Continuous Forward Current	$T_A = 25^\circ\text{C}$	-2	A
<b>Mounted on Large Heat Sink</b>				
$I_{DM}$	Pulse Drain Current Tested ①	$T_A = 25^\circ\text{C}$	-52	A
$I_D$	Continuous Drain current@ $V_{GS}=-10V$	$T_A = 25^\circ\text{C}$	-13	A
$P_D$	Maximum Power Dissipation	$T_A = 25^\circ\text{C}$	2.5	W
		$T_A = 70^\circ\text{C}$	1.3	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case	50	°C/W	
$R_{\theta JA}$	Thermal Resistance Junction-Ambient( $t_s < 10s$ )	25	°C/W	
<b>Drain-Source Avalanche Ratings</b>				
EAS	Avalanche Energy, Single Pulsed ②	36	mJ	

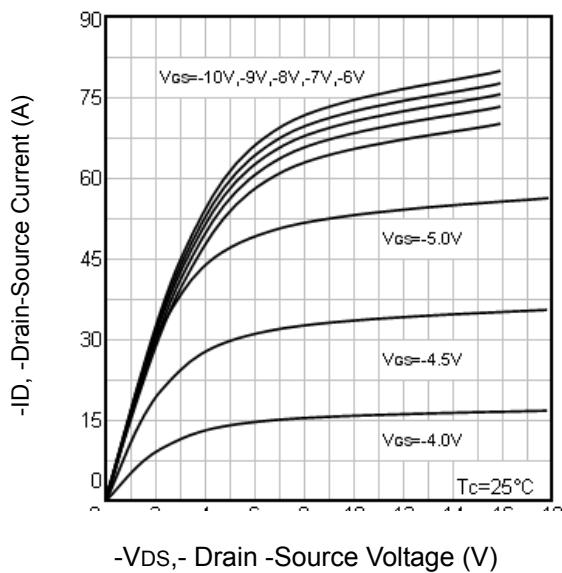
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_A = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_j=25^\circ\text{C}$ )	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	-1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ )	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	-100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1.0	-1.6	-2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance <sup>③</sup>	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-8\text{A}$	--	11	16	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance <sup>③</sup>	$V_{\text{GS}}=-5\text{V}, I_{\text{D}}=-8\text{A}$	--	15	26	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_A = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	--	1950	--	pF
$C_{\text{oss}}$	Output Capacitance		--	320	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	225	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-10\text{A}, V_{\text{GS}}=-10\text{V}$	--	28	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	4.5	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	9	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-15\text{V}, I_{\text{D}}=-1\text{A}, R_{\text{G}}=6.8\Omega, V_{\text{GS}}=-10\text{V}$	--	9	--	nS
$t_r$	Turn-on Rise Time		--	10	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	22	--	nS
$t_f$	Turn-Off Fall Time		--	11	--	nS
<b>Source- Drain Diode Characteristics@ <math>T_A = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$I_{\text{SD}}$	Source-drain current(Body Diode)	$T_c=25^\circ\text{C}$	--	--	-60	A
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=-9\text{A}, V_{\text{GS}}=0\text{V}$	--	0.82	-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{sd}}=-8\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=-100\text{A}/\mu\text{s}$	--	26	--	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		--	35	--	nC

NOTE:

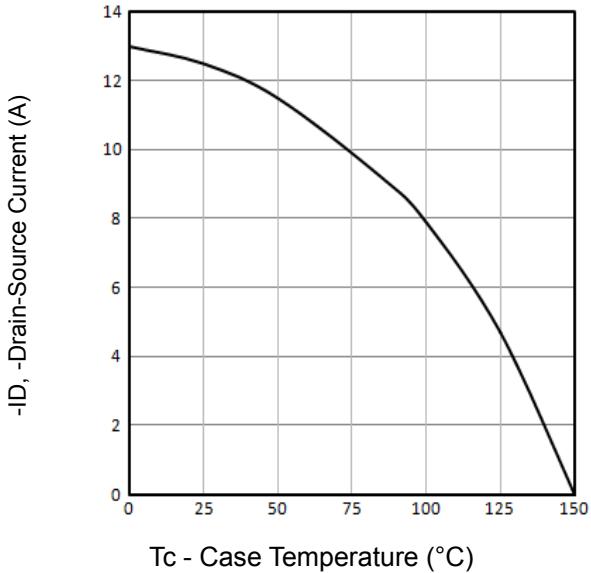
① Repetitive rating; pulse width limited by max. junction temperature.

② Limited by TJmax, starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{\text{AS}} = -12\text{A}$ ,  $V_{\text{GS}} = -10\text{V}$ . Part not recommended for use above this value③ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

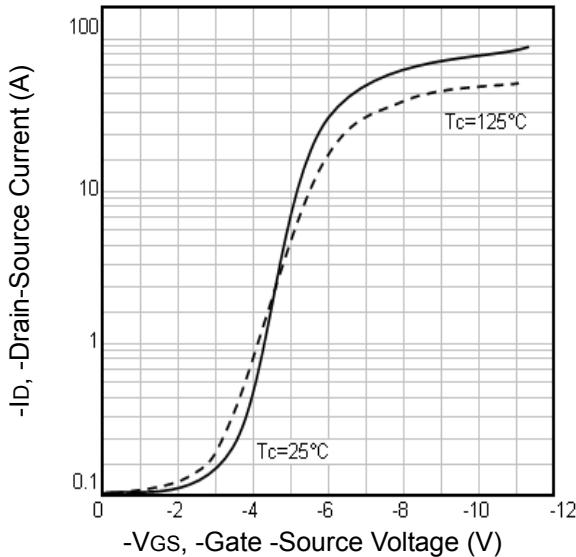
## Typical Characteristics



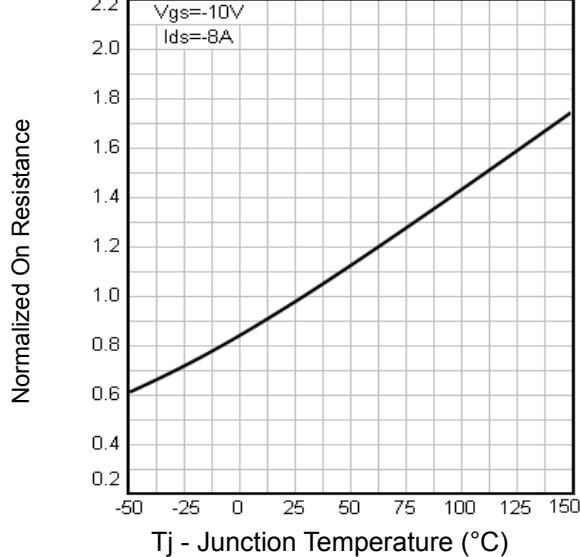
**Fig1.** Typical Output Characteristics



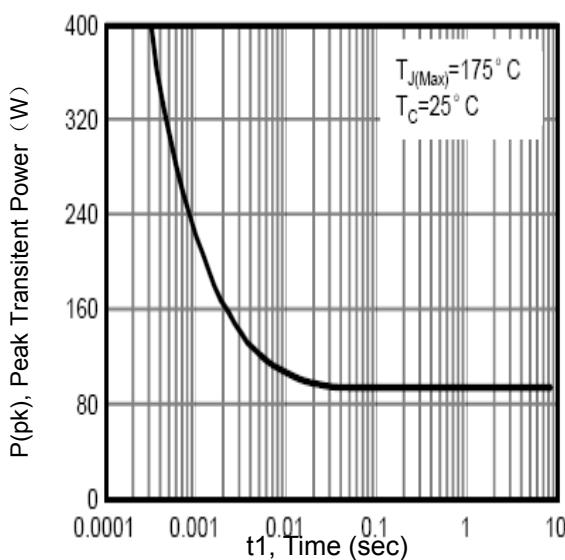
**Fig2.** Maximum Drain Current Vs. Case Temperature



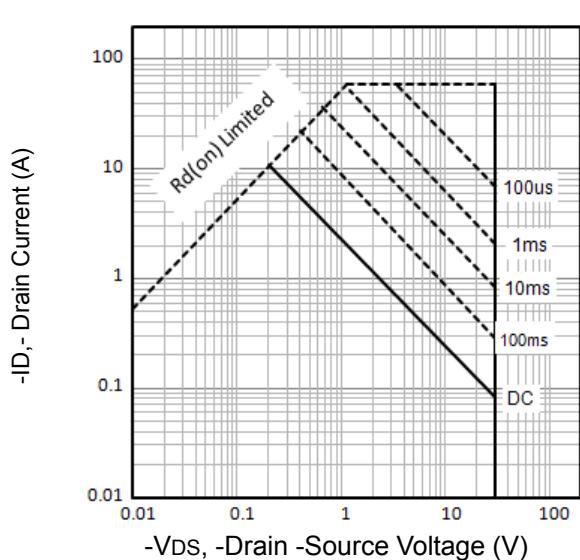
**Fig3.** Typical Transfer Characteristics



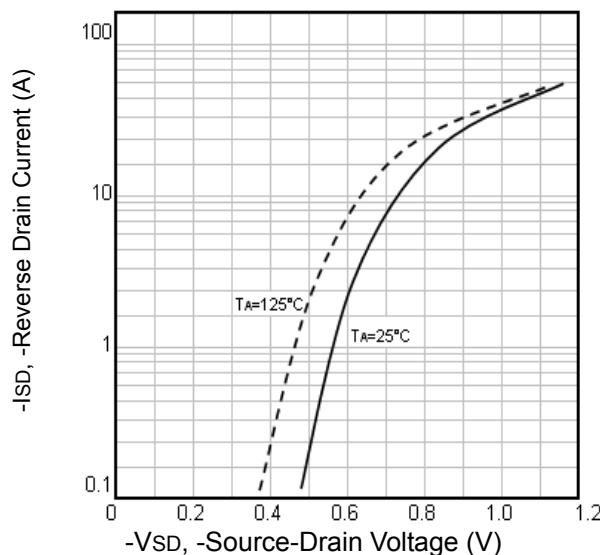
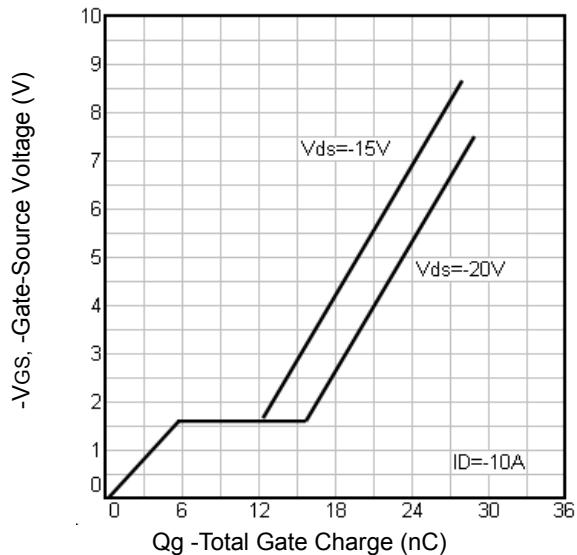
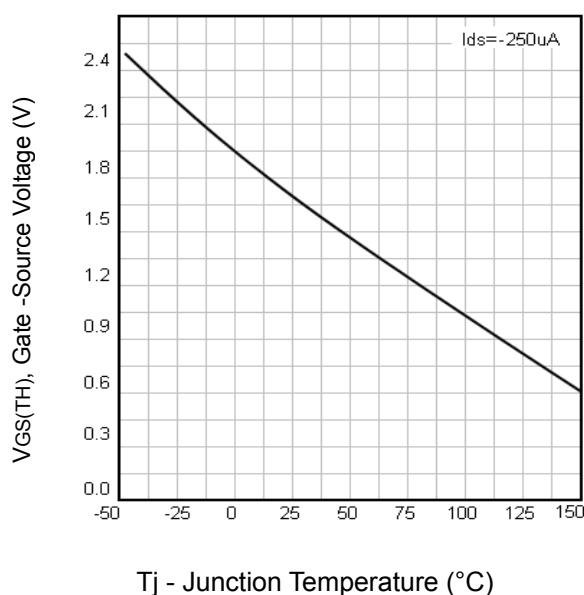
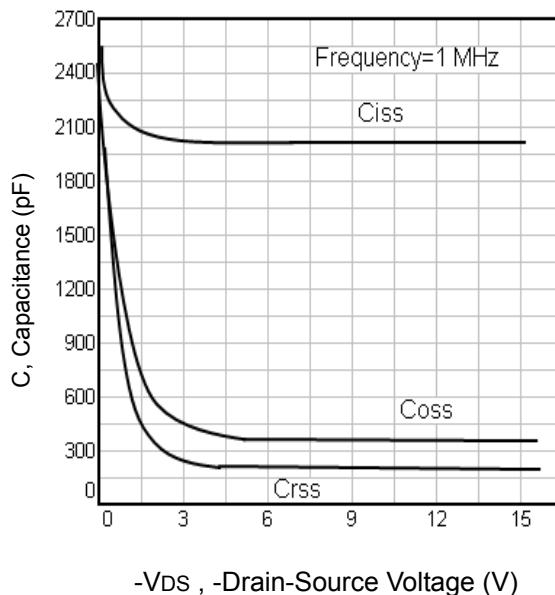
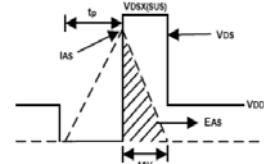
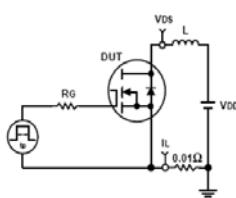
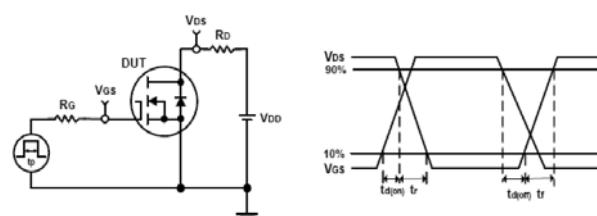
**Fig4.** Normalized On-Resistance Vs. Temperature



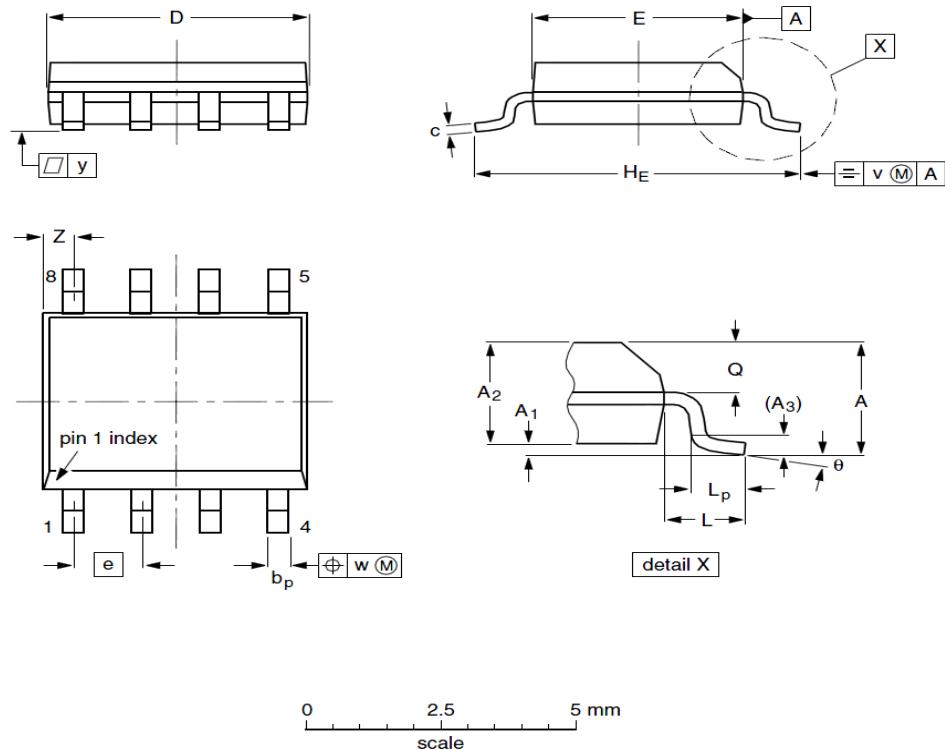
**Fig5.** Typical Peak Transient Power



**Fig6.** Maximum Safe Operating Area


**Fig7.** Typical Source-Drain Diode Forward Voltage

**Fig8.** Typical Gate Charge Vs.Gate-Source Voltage

**Fig9.** Threshold Voltage Vs. Temperature

**Fig10.** Typical Capacitance Vs.Drain-Source Voltage

**Fig11.** Unclamped Inductive Test Circuit and Waveforms

**Fig12.** Switching Time Test Circuit and waveforms

### SOP8 Package Outline



### DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	--	1.75	--	A <sub>1</sub>	0.10	0.18	0.25
A <sub>2</sub>	1.25	1.35	1.45	A <sub>3</sub>	--	0.25	--
b <sub>p</sub>	0.36	0.42	0.49	c	0.19	0.22	0.25
D	4.80	4.92	5.00	E	3.80	3.90	4.00
e	--	1.27	--	H <sub>E</sub>	5.80	5.98	6.20
L	--	1.05	--	L <sub>p</sub>	0.40	0.68	1.00
Q	0.60	0.65	0.70	v	--	0.25	--
w	--	0.25	--	y	--	0.10	--
Z	0.30	0.50	0.70	θ	0°		8°

Product	Marking	Package	Packaging	Min Unit Quantity
VS4407AS	4407AS	SOP8	3000/Reel	6000

### Customer Service

#### Sales and Service:

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